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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Leonardo Estevez et al.  
Serial No: 10/025,531  
Filed: 12/19/2001  
Art Unit: 2621  
Examiner: Amir Alavi  
Docket No.: TI-31793  
Conf. No.: 6204  
Customer No.: 23494

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NAME OF INVENTOR(S): Leonardo Estevez et al.	
RECEIPT DATE & SERIAL NO.: Serial No.: 10/025,531	
TITLE OF INVENTION: Image Compression	
Filing Date: 12/19/2001	
Conf. No.: 6204	
TITLE NO.: TI-31793	DEPOSIT ACCT. NO.: 20-0668
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